

N-Channel 250-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$Rr_{DS(on)}\left(\Omega\right)$	I _D (A)			
250	0.155 at V _{GS} = 10 V	3.0			
	0.162 at V _{GS} = 6.0 V	2.9			

FEATURES

PWM-Optimized TrenchFET® Power MOSFET

• Halogen-free According to IEC 61249-2-21

• 100 % R_q Tested

Definition

Avalanche Tested





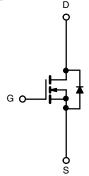
SO-8 D S D

Top View Ordering Information: Si4434DY-T1-E3 (Lead (Pb)-free)

Si4434DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- · Primary Side Switch In:
 - Telecom Power Supplies
 - Distributed Power Architectures
 - Miniature Power Modules



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise i	noted			
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	250		V	
Gate-Source Voltage		V _{GS}	± 20		V	
Continuous Dunin Comment/T 150 9C\d	T _A = 25 °C	3.0 2.1		2.1		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	- I _D	2.4	1.7	1	
Pulsed Drain Current		I _{DM}	30		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	2.6	1.3		
Avalanche Current	L = 0.1 mH	I _{AS}		13	1	
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	8.4		mJ	
Mariana Barra Biraira kang	T _A = 25 °C	P _D	3.1	1.56	W	
Maximum Power Dissipation ^a	T _A = 70 °C	' D	2.0	1.0	l vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana landia ta Andria 18	t ≤ 10 s	R _{thJA}	33	40	
Maximum Junction-to-Ambient ^a	Steady State	' ¹thJA	65	80	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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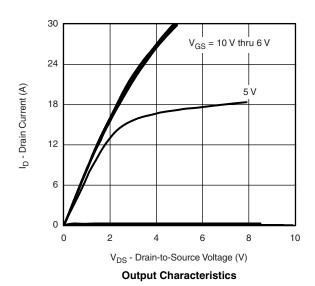
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.0		4.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	L	V _{DS} = 250 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			15		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	В	V _{GS} = 10 V, I _D = 3.0 A		0.129	0.155	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 2.9 \text{ A}$		0.131	0.162		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 3.0 A		14		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.8 A, V _{GS} = 0 V		0.75	1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			34	50		
Gate-Source Charge	Q_{gs}	V _{DS} = 100 V, V _{GS} = 10 V, I _D = 3.0 A		6.8		nC	
Gate-Drain Charge	Q_{gd}			10.5			
Gate Resistance	R_g		0.6	1.2	1.8	Ω	
Turn-On Delay Time	t _{d(on)}			16	25		
Rise Time	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 25 \Omega$		23	35	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 4.0$ A, $V_{GEN}=10$ V, $R_g=6$ Ω		47	70		
Fall Time	t _f			19	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, dI/dt = 100 A/μs		100	150		

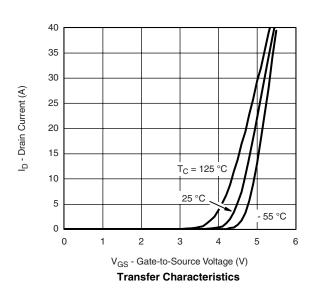
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



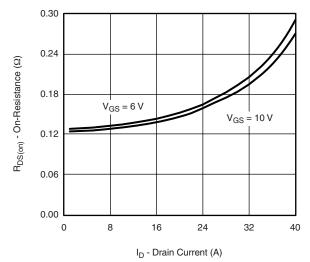




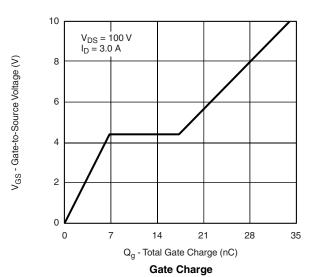




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current

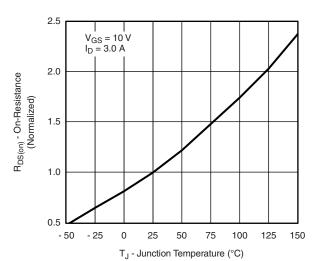


 $T_{\rm J} = 150~{\rm ^{\circ}C}$ 10 $T_{\rm J} = 150~{\rm ^{\circ}C}$ 10.0 0.2 0.4 0.6 0.8 1.0 1.2 $V_{\rm DS}$ - Source-to-Drain Voltage (V)

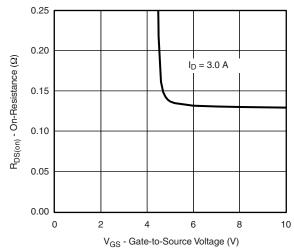
Source-Drain Diode Forward Voltage

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V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



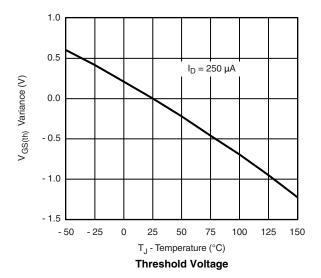
On-Resistance vs. Gate-to-Source Voltage

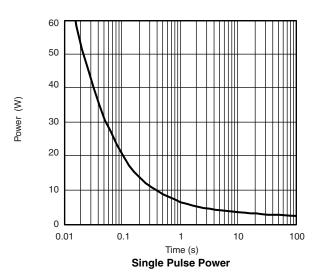
I_S - Source Current (A)

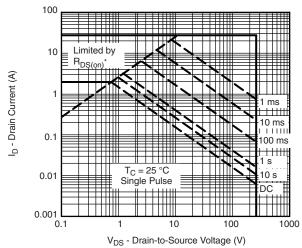
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

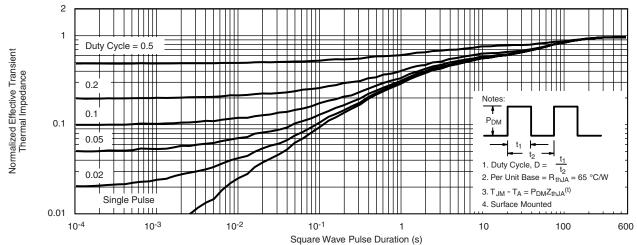






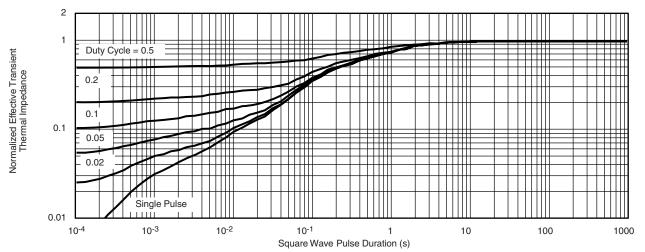
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



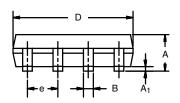
Normalized Thermal Transient Impedance, Junction-to-Foot

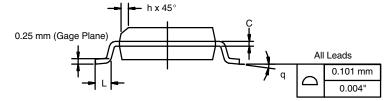
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







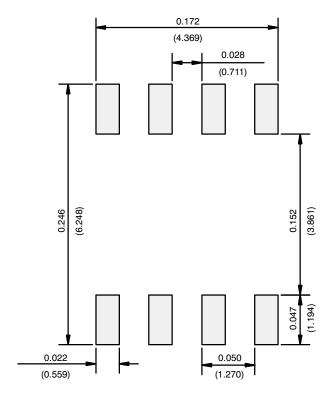
	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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